

1.Features

UMTS, LTE Band

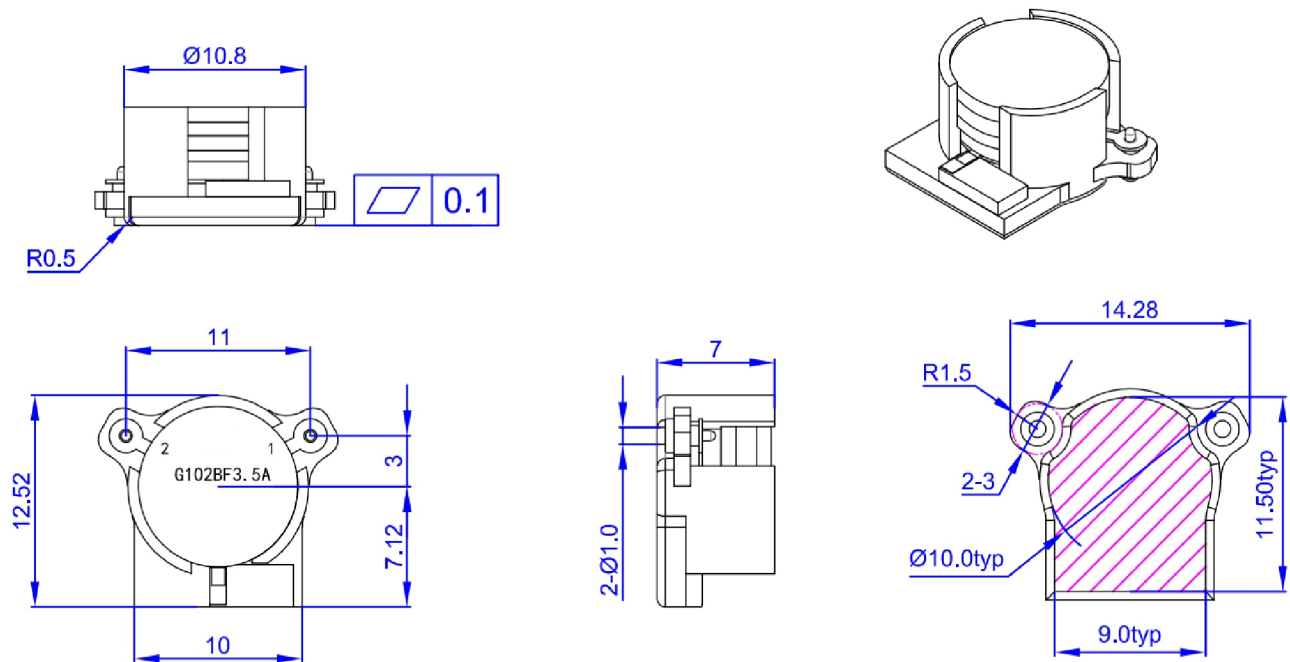
PCB Soldering Re-flow

Wide Operation Temperature Range -45 ~ 125℃

Compact Package Design for PCB Applications

2.Dimensions

Unit:mm



3.Specifications

Part No.	Frequency (GHz)		Center Frequency	Bandwidth	Isolation	INS LOSS	VSWR	Power	IMD (@2X43dBm)
	F1	F2	(GHz)	(GHz)	(dB) MIN	(dB) MAX	(dB) MAX	(W)	(-dBc) MAX
G102BF1.8-2.1G	1.805	2.170	1.9875	0.365	17	0.55	1.33	20	-50
G102BZ2G	1.980	2.010	1.9950	0.030	23	0.3	1.15	20	-65
G102BF2.6G	2.456	2.730	2.5930	0.274	20	0.35	1.17	20	-72